## XN0F256

### Silicon NPN epitaxial planar type

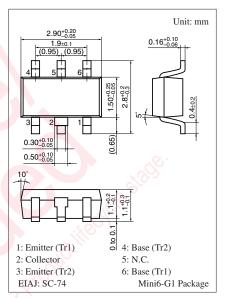
#### For muting

#### ■ Features

- Two elements incorporated into one package (Collector-coupled transistors with built-in resistor)
- $\bullet$  Low collector-emitter saturation voltage  $V_{\text{CE}(\text{sat})}$
- Reduction of the mounting area and assembly cost by one half

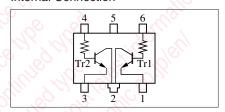
### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	$V_{CBO}$	30	V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	20	V
Emitter-base voltage (Collector open)	$V_{EBO}$	5	V
Collector current	$I_{C}$	600	mA
Total power dissipation	$P_{T}$	300	mW
Junction temperature	$T_{j}$	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C



Marking Symbol: 6A

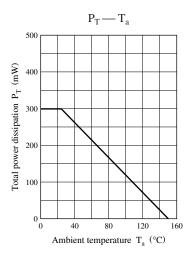
#### Internal Connection

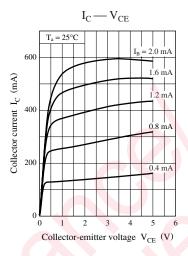


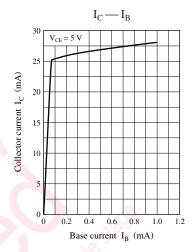
### ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

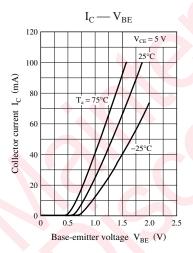
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_C = 1 \mu A, I_E = 0$	30			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = 1 \text{ mA}, I_B = 0$	20			V
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_E = 1 \mu A, I_C = 0$	5			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 30 \text{ V}, I_E = 0$			1	μΑ
Emitter-base cutoff current (Collector open)	$I_{EBO}$	$V_{EB} = 5 \text{ V}, I_C = 0$			1	μΑ
Forward current transfer ratio	$h_{FE}$	$V_{CE} = 5 \text{ V}, I_{C} = 50 \text{ mA}$	100		600	_
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 50 \text{ mA}, I_B = 2.5 \text{ mA}$			80	mV
Input resistance	$R_1$		-30%	4.7	+30%	kΩ
Transition frequency	$f_T$	$V_{CB} = 10 \text{ V}, I_{E} = -50 \text{ mA}, f = 200 \text{ MHz}$		200		MHz

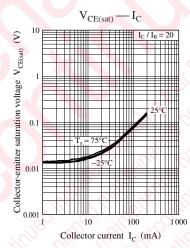
Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

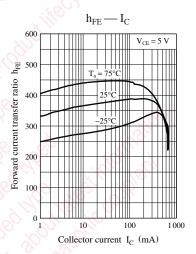












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